

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Ja-Kyung Cho	09/01/2011
RECEIVING PARTY DATA	
Name:	Samsung SDI Co., Ltd.
Street Address:	428-5 Gongse-Dong, Giheung-Gu
City:	Yongin-si, Gyeonggi-do
State/Country:	REPUBLIC OF KOREA
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13230731
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ATTORNEY DOCKET NUMBER:	SDIYPL.411AUS
NAME OF SUBMITTER:	Nora Marachelian
Total Attachments: 1 source=Assignment_SDYPL_411AUS#page1.tif	

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Application No.: Unknown
Filing Date: Filed Herewith

Client Code: SDIYPL411AUS
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ASSIGNMENT

WHEREAS, I, the undersigned, have invented certain new and useful improvements in a **PACKING CASE FOR BATTERY, SECONDARY BATTERY USING THE SAME, AND METHOD OF MANUFACTURING THE SECONDARY BATTERY**, the specification of which is filed on even date herewith,

AND WHEREAS, Samsung SDI Co., Ltd., (hereinafter "ASSIGNEE"), with its principal place of business at 428-5, Gongse-Dong, Giheung-Gu, Yongin-Si, Gyeonggi-do, Republic of Korea, desires to acquire the entire right, title, and interest in and to the said improvements with respect to the United States of America, its territories and possessions.

NOW, THEREFORE, in light of good and valuable consideration, the receipt of which is hereby acknowledged, I, the said inventor, do hereby acknowledge that I have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, the entire right, title, and interest throughout the world in, to and under the said improvements, and the said application and all provisional applications relating thereto, and all divisions, renewals and continuations thereof, and all Letters Patent of the United States which may be granted thereon and all reissues and extensions thereof, and all rights of priority under International Conventions and applications for Letters Patent which may hereafter be filed for said improvements in any country or countries foreign to the United States, and all Letters Patent which may be granted for said improvements in any country or countries foreign to the United States and all extensions, renewals and reissues thereof, and I hereby authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said improvements to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND I HEREBY covenant and agree that I will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to me respecting said improvements, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said improvements in all countries.

Date:

1/September/2011

Signature:

CHO - JA KYUNG

Name: Ja-Kyung CHO

Address : c/o Samsung SDI Co., Ltd.
428-5, Gongse-Dong, Giheung-Gu, Yongin-Si,
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